

PSMN030-150P,127-VB Datasheet N-Channel 150-V (D-S) 175 °C MOSFET

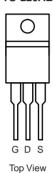
PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)			
150	0.030 at V _{GS} = 10 V	50			
	0.033 at V _{GS} = 6 V	45			

FEATURES

- Trench Power MOSFETs
- 175 °C Junction Temperature
- New Low Thermal Resistance Package
- PWM Optimized
- Compliant to RoHS Directive 2002/95/EC

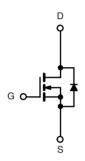


TO-220AB



APPLICATIONS

· Primary Side Switch



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	10 = 20 °C, arricos otri			
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	150	V
Gate-Source Voltage	V _{GS}	± 20	· ·	
Continuous Drain Current (T _{.1} = 175 °C)	T _C = 25 °C	I-	50	
Continuous Diain Curient (1) = 175 C)	T _C = 125 °C		35	A
Pulsed Drain Current		I _{DM}	150	7
Avalanche Current		I _{AR}	50	
Repetitive Avalanche Energy ^a	L = 0.1 mH	E _{AR}	80	mJ
Mariana Barra Biratinalian	T _C = 25 °C	В	166 ^b	10/
Maximum Power Dissipation ^a	T _A = 25 °C ^c	$ P_D$ $-$	3.75	W
Operating Junction and Storage Temperature Rai	nge	T _J , T _{sta}	- 55 to 175	°C

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Limit	Unit		
Junction-to-Ambient ^c	R _{thJA}	40	°C/W		
Junction-to-Case (Drain)	R _{thJC}	0.9	C/VV		

Notes:

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.
- c. When Mounted on 1" square PCB (FR-4 material).



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{DS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	150			V	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2		4	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
		V _{DS} = 120 V, V _{GS} = 0 V			1	μΑ	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 120 V, V _{GS} = 0 V, T _J = 125 °C			50		
		V _{DS} = 120 V, V _{GS} = 0 V, T _J = 175 °C			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	80			Α	
		V _{GS} = 10 V, I _D = 15 A		0.030		1	
	D	$V_{GS} = 6 \text{ V}, I_{D} = 10 \text{ A}$		0.033		Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 15 A, T _J = 125 °C		0.076			
		V _{GS} = 10 V, I _D = 15 A, T _J = 175 °C		0.100			
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A	10			S	
Dynamic ^b	•			1			
Input Capacitance	C _{iss}			2500		pF	
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz		290			
Reverse Transfer Capacitance	C _{rss}			190			
Gate Resistance	R_{g}			2		Ω	
Total Gate Charge ^c	Qg			38	60	nC	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 75 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 40 \text{ A}$		13			
Gate-Drain Charge ^c	Q _{gd}			13			
Turn-On Delay Time ^c	t _{d(on)}			15	25		
Rise Time ^c	t _r	$V_{DD} = 75 \text{ V}, R_{L} = 1.80 \Omega$		130	200	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 40 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$		30	45		
Fall Time ^c	t _f	-		90	140		
Source-Drain Diode Ratings and Cha	aracteristics	T _C = 25 °C ^b					
Continuous Current	Is				40		
Pulsed Current	I _{SM}				80	A	
Forward Voltage ^a	V _{SD}	I _F = 40 A, V _{GS} = 0 V		1.0	1.5	V	
Reverse Recovery Time	t _{rr}	. 25		100	150	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 40 A, dl/dt = 100 A/μs		5	8	A	
Reverse Recovery Charge	Q _{rr}	, , , , , , , , , , , , , , , , , , , ,		0.25	0.6	иC	

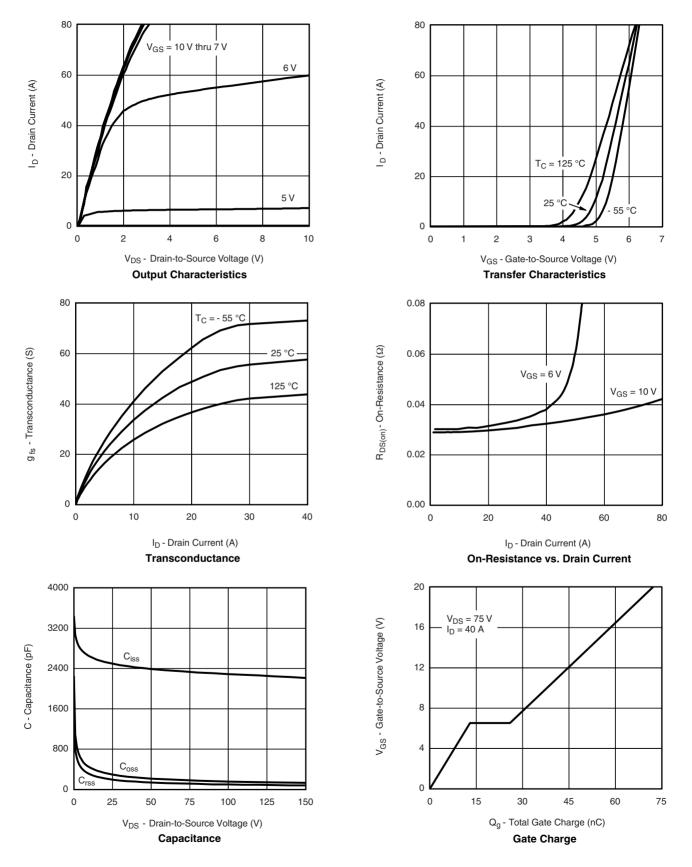
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

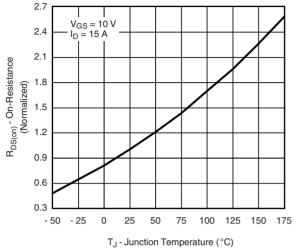


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

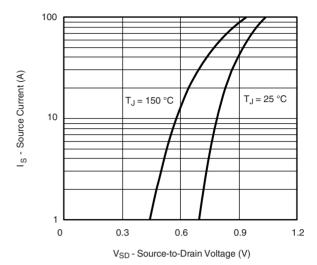




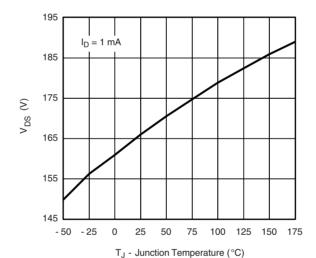
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







Source-Drain Diode Forward Voltage

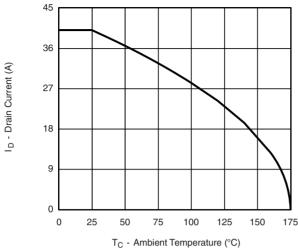


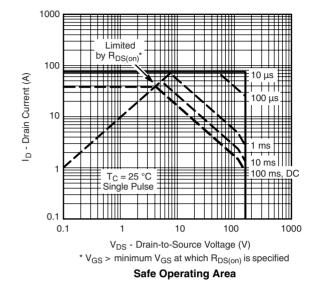
Drain Source Breakdown vs. Junction Temperature

服务热线:400-655-8788

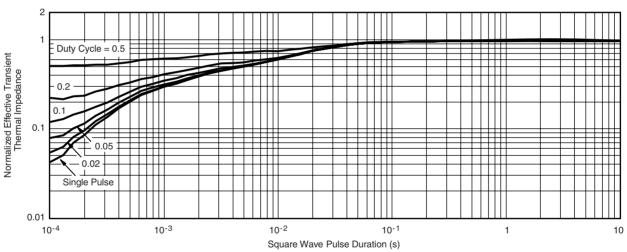


THERMAL RATINGS





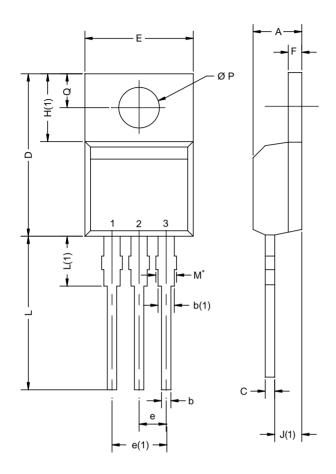
Maximum Avalanche and Drain Current vs. Case Temperature



Normalized Thermal Transient Impedance, Junction-to-Case



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	MILLIMETERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØΡ	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
ECN: X12-0208-Rev. N, 08-Oct-12 DWG: 5471					

Notes

服务热线:400-655-8788

 $^{^{\}star}$ M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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